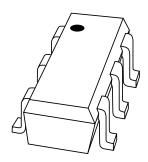
## DISCRETE SEMICONDUCTORS

## DATA SHEET



# **BGM1012**MMIC wideband amplifier

Product specification Supersedes data of 2002 May 16 2002 Sep 06



## **MMIC** wideband amplifier

**BGM1012** 

#### **FEATURES**

- Internally matched to 50  $\Omega$
- Very wide frequency range (4 GHz at 3 dB bandwidth)
- Very flat 20 dB gain (DC to 2.9 GHz at 1 dB flatness)
- 10 dBm saturated output power at 1 GHz
- High linearity (18 dBm IP3<sub>(out)</sub> at 1 GHz)
- Low current (14.6 mA)
- · Unconditionally stable.

## **APPLICATIONS**

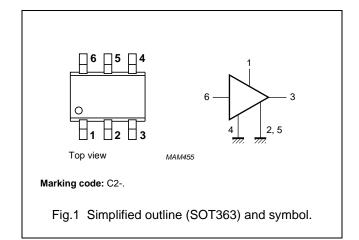
- · LNB IF amplifiers
- · Cable systems
- ISM
- · General purpose.

## **DESCRIPTION**

Silicon Monolithic Microwave Integrated Circuit (MMIC) wideband amplifier with internal matching circuit in a 6-pin SOT363 SMD plastic package.

#### **PINNING**

| PIN  | DESCRIPTION    |
|------|----------------|
| 1    | V <sub>S</sub> |
| 2, 5 | GND2           |
| 3    | RF out         |
| 4    | GND1           |
| 6    | RF in          |



## **QUICK REFERENCE DATA**

| SYMBOL                         | PARAMETER            | CONDITIONS | TYP. | MAX. | UNIT |
|--------------------------------|----------------------|------------|------|------|------|
| V <sub>S</sub>                 | DC supply voltage    |            | 3    | 4    | V    |
| Is                             | DC supply current    |            | 14.6 | _    | mA   |
| s <sub>21</sub>   <sup>2</sup> | insertion power gain | f = 1 GHz  | 20.1 | _    | dB   |
| NF                             | noise figure         | f = 1 GHz  | 4.8  | _    | dB   |
| P <sub>L(sat)</sub>            | saturated load power | f = 1 GHz  | 9.7  | _    | dBm  |

## **CAUTION**

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling.

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## **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL           | PARAMETER                      | CONDITIONS             | MIN. | MAX. | UNIT |
|------------------|--------------------------------|------------------------|------|------|------|
| Vs               | DC supply voltage              | RF input AC coupled    | _    | 4    | V    |
| Is               | supply current                 |                        | _    | 50   | mA   |
| P <sub>tot</sub> | total power dissipation        | T <sub>s</sub> ≤ 90 °C | _    | 200  | mW   |
| T <sub>stg</sub> | storage temperature            |                        | -65  | +150 | °C   |
| T <sub>j</sub>   | operating junction temperature |                        | _    | 150  | °C   |
| P <sub>D</sub>   | maximum drive power            |                        | _    | 10   | dBm  |

## THERMAL CHARACTERISTICS

| SYMBOL              | PARAMETER  | CONDITIONS                          | VALUE | UNIT |
|---------------------|--|-------------------------------------|-------|------|
| R <sub>th j-s</sub> | thermal resistance from junction to solder point | $P_{tot}$ = 200 mW; $T_s \le 90$ °C | 300   | K/W  |

## MMIC wideband amplifier

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## **CHARACTERISTICS**

 $V_S$  = 3 V;  $I_S$  = 14.6 mA;  $T_j$  = 25 °C; unless otherwise specified.

| SYMBOL                         | PARAMETER              | CONDITIONS                                     | MIN. | TYP. | MAX. | UNIT |
|--------------------------------|------------------------|--|------|------|------|------|
| I <sub>S</sub>                 | supply current         |  | 11   | 14.6 | 19   | mA   |
| s <sub>21</sub>   <sup>2</sup> | insertion power gain   | f = 100 MHz                                    | 19   | 19.5 | 20   | dB   |
|                                |                        | f = 1 GHz                                      | 19   | 20.1 | 21   | dB   |
|                                |                        | f = 1.8 GHz                                    | 19   | 20.4 | 21   | dB   |
|                                |                        | f = 2.2 GHz                                    | 19   | 20.4 | 22   | dB   |
|                                |                        | f = 2.6 GHz                                    | 18   | 19.9 | 21   | dB   |
|                                |                        | f = 3 GHz                                      | 16   | 18.7 | 20   | dB   |
| R <sub>L IN</sub>              | return losses input    | f = 1 GHz                                      | 9    | 11   | _    | dB   |
|                                |                        | f = 2.2 GHz                                    | 13   | 15   | _    | dB   |
| R <sub>L OUT</sub>             | return losses output   | f = 1 GHz                                      | 11   | 14   | _    | dB   |
|                                |                        | f = 2.2 GHz                                    | 10   | 13   | _    | dB   |
| s <sub>12</sub>  2             | isolation              | f = 1 GHz                                      | 30   | 33   | _    | dB   |
|                                |                        | f = 2.2 GHz                                    | 35   | 38   | _    | dB   |
| NF                             | noise figure           | f = 1 GHz                                      | _    | 4.8  | 5.1  | dB   |
|                                |                        | f = 2.2 GHz                                    | _    | 4.9  | 5.3  | dB   |
| BW                             | bandwidth              | at $ s_{21} ^2$ –3 dB below flat gain at 1 GHz | 3.1  | 3.6  | _    | GHz  |
| K                              | stability factor       | f = 1 GHz                                      | 1.5  | 2.1  | _    | _    |
|                                |                        | f = 2.2 GHz                                    | 3    | 3.4  | _    | _    |
| P <sub>L(sat)</sub>            | saturated load power   | f = 1 GHz                                      | 8    | 9.7  | _    | dBm  |
|                                |                        | f = 2.2 GHz                                    | 3.5  | 5.6  | _    | dBm  |
| P <sub>L 1 dB</sub>            | load power             | at 1 dB gain compression; f = 1 GHz            | 4    | 6.0  | _    | dBm  |
|                                |                        | at 1 dB gain compression; f = 2.2 GHz          | 1.5  | 3.4  | _    | dBm  |
| IP3 <sub>(in)</sub>            | input intercept point  | f = 1 GHz                                      | -4   | -2   | _    | dBm  |
|                                |                        | f = 2.2 GHz                                    | -9   | -7   | _    | dBm  |
| IP3 <sub>(out)</sub>           | output intercept point | f = 1 GHz                                      | 16   | 18   | _    | dBm  |
|                                |                        | f = 2.2 GHz                                    | 11   | 13   | _    | dBm  |

## MMIC wideband amplifier

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#### APPLICATION INFORMATION

Figure 2 shows a typical application circuit for the BGM1012 MMIC. The device is internally matched to  $50~\Omega$ , and therefore does not need any external matching. The value of the input and output DC blocking capacitors C2 and C3 should not be more than 100 pF for applications above 100 MHz. However, when the device is operated below 100 MHz, the capacitor value should be increased.

The nominal value of the RF choke L1 is 100 nH. At frequencies below 100 MHz this value should be increased to 220 nH. At frequencies above 1 GHz a much lower value (e.g. 10 nH) can be used to improve return losses. For optimal results, a good quality chip inductor such as the TDK MLG 1608 (0603), or a wire-wound SMD type should be chosen.

Both the RF choke L1 and the 22 nF supply decoupling capacitor C1 should be located as closely as possible to the MMIC.

Separate paths must be used for the ground planes of the ground pins GND1 and GND2, and these paths must be as short as possible. When using vias, use multiple vias per pin in order to limit ground path inductance.

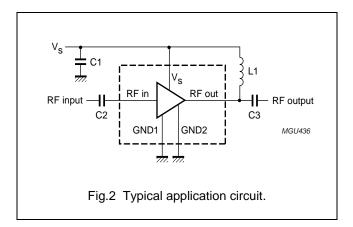
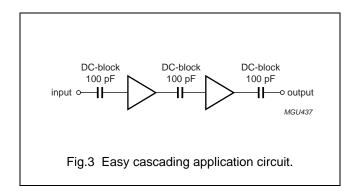


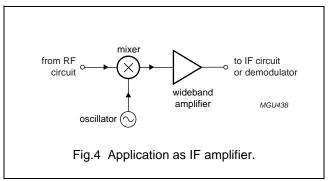
Figure 3 shows two cascaded MMICs. This configuration doubles overall gain while preserving broadband characteristics. Supply decoupling and grounding conditions for each MMIC are the same as those for the circuit of Fig.2.

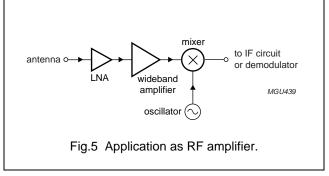
The excellent wideband characteristics of the MMIC make it an ideal building block in IF amplifier applications such as LBNs (see Fig.4).

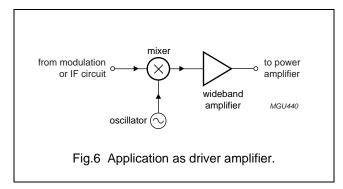
As a buffer amplifier between an LNA and a mixer in a receiver circuit, the MMIC offers an easy matching, low noise solution (see Fig.5).

In Fig.6 the MMIC is used as a driver to the power amplifier as part of a transmitter circuit. Good linear performance and matched input and output offer quick design solutions in such applications.





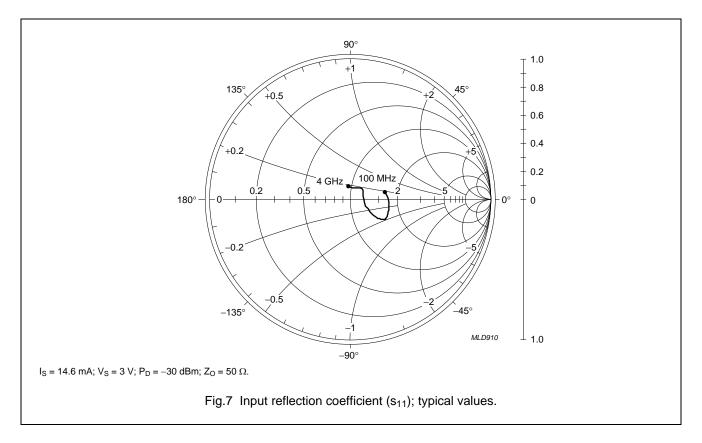


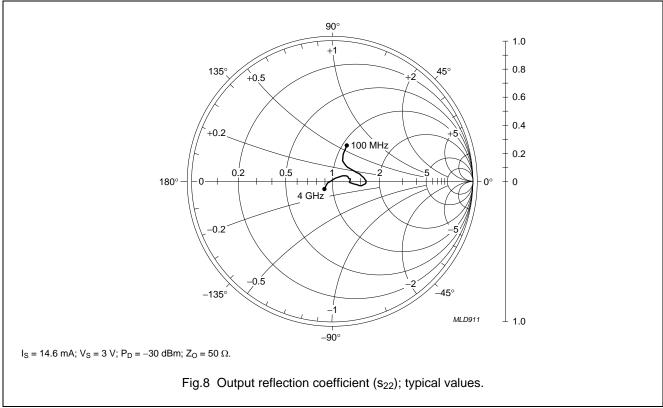


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## MMIC wideband amplifier

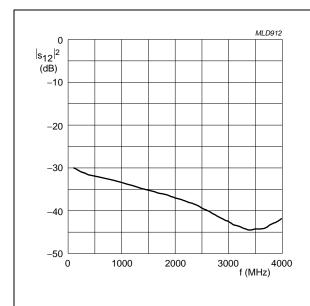
BGM1012





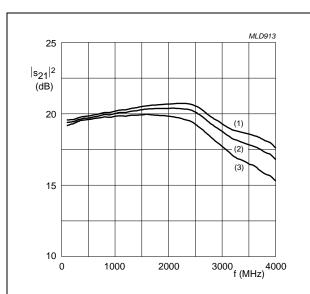
## MMIC wideband amplifier

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 $I_S$  = 14.6 mA;  $V_S$  = 3 V;  $P_D$  = –30 dBm;  $Z_O$  = 50  $\Omega.$ 

Fig.9 Isolation ( $|s_{12}|^2$ ) as a function of frequency; typical values.



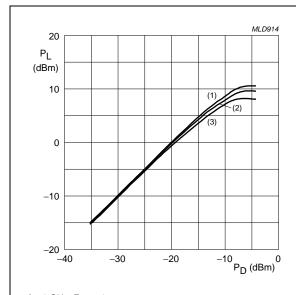
 $P_D = -30 \text{ dBm}; Z_O = 50 \Omega.$ 

(1)  $I_S = 18.7 \text{ mA}$ ;  $V_S = 3.3 \text{ V}$ .

(2)  $I_S = 14.6 \text{ mA}$ ;  $V_S = 3 \text{ V}$ .

(3)  $I_S = 10.6 \text{ mA}$ ;  $V_S = 2.7 \text{ V}$ .

Fig.10 Insertion gain (|s<sub>21</sub>|<sup>2</sup>) as a function of frequency; typical values.



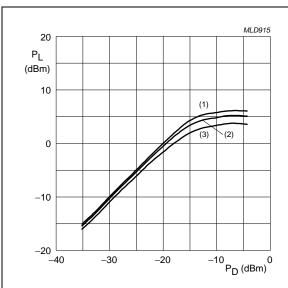
 $f = 1 \text{ GHz}; Z_O = 50 \Omega.$ 

(1)  $V_S = 3.3 V$ .

(2)  $V_S = 3 V$ .

(3)  $V_S = 2.7 V$ .

Fig.11 Load power as a function of drive power at 1 GHz; typical values.



 $f = 2.2 \text{ GHz}; Z_O = 50 \Omega.$ 

(1)  $V_S = 3.3 V$ .

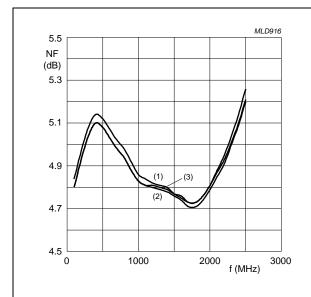
(2)  $V_S = 3 V$ .

(3)  $V_S = 2.7 V$ .

Fig.12 Load power as a function of drive power at 2.2 GHz; typical values.

## MMIC wideband amplifier

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 $Z_{O} = 50 \ \Omega$ .

- (1)  $I_S = 10.6 \text{ mA}$ ;  $V_S = 2.7 \text{ V}$ .
- (2)  $I_S = 14.6 \text{ mA}$ ;  $V_S = 3 \text{ V}$ .
- (3)  $I_S = 18.7 \text{ mA}$ ;  $V_S = 3.3 \text{ V}$ .

Fig.13 Noise figure as a function of frequency; typical values.

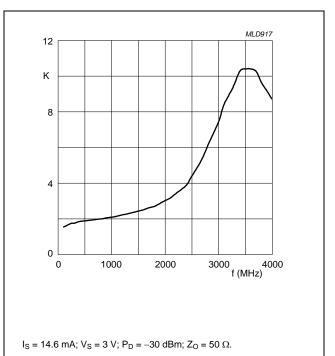


Fig.14 Stability factor as a function of frequency;

typical values.

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| Sca | ittering | parameters |   |
|-----|----------|------------|---|
|     |          |            | _ |

 $V_S$  = 3 V;  $I_S$  = 14.6 mA;  $P_D$  = –30 dBm;  $Z_O$  = 50  $\Omega;$   $T_{amb}$  = 25  $^{\circ}C.$ 

|         | S <sub>11</sub>   | s <sub>11</sub> |                   |                | s <sub>12</sub>   |                | s <sub>22</sub>   |                | - K-   |
|---------|-------------------|-----------------|-------------------|----------------|-------------------|----------------|-------------------|----------------|--------|
| f (MHz) | MAGNITUDE (ratio) | ANGLE<br>(deg)  | MAGNITUDE (ratio) | ANGLE<br>(deg) | MAGNITUDE (ratio) | ANGLE<br>(deg) | MAGNITUDE (ratio) | ANGLE<br>(deg) | FACTOR |
| 100     | 0.25122           | 14.607          | 9.33681           | 12.018         | 0.032124          | 16.445         | 0.26458           | 64.156         | 1.6    |
| 200     | 0.27070           | 2.759           | 9.42458           | 5.676          | 0.028303          | 6.37           | 0.20645           | 64.153         | 1.8    |
| 400     | 0.27979           | -7.969          | 9.63627           | -8.447         | 0.026297          | -4.545         | 0.1543            | 52.558         | 1.9    |
| 600     | 0.28323           | -14.78          | 9.76543           | -19.02         | 0.024833          | -10.24         | 0.15203           | 39.347         | 1.9    |
| 800     | 0.28557           | -20.13          | 9.93782           | -27.93         | 0.023234          | -14.62         | 0.16867           | 27.926         | 2.0    |
| 1000    | 0.28673           | -24.14          | 10.03633          | -36.88         | 0.021523          | -17.42         | 0.19196           | 19.293         | 2.1    |
| 1200    | 0.28517           | -27.57          | 10.11638          | -46.47         | 0.019830          | -19.83         | 0.21421           | 12.703         | 2.2    |
| 1400    | 0.27902           | -29.93          | 10.26450          | -56.05         | 0.018230          | -21.14         | 0.23292           | 7.154          | 2.4    |
| 1600    | 0.26682           | -31.81          | 10.40572          | -65.76         | 0.016902          | -21.62         | 0.24605           | 2.582          | 2.5    |
| 1800    | 0.24746           | -33.12          | 10.44088          | -76.97         | 0.015759          | -22.32         | 0.25113           | -1.26          | 2.7    |
| 2000    | 0.21894           | -33.8           | 10.46224          | -88.33         | 0.014310          | -22.64         | 0.24367           | -4.817         | 3.0    |
| 2200    | 0.18164           | -32.67          | 10.45202          | -100.3         | 0.013012          | -23.13         | 0.22184           | -7.573         | 3.4    |
| 2400    | 0.14000           | -26.75          | 10.34342          | -112.6         | 0.011826          | -23.27         | 0.18787           | -8.489         | 3.9    |
| 2600    | 0.10418           | -10.16          | 9.87989           | -122.9         | 0.010171          | -23.23         | 0.13049           | -4.601         | 4.9    |
| 2800    | 0.09469           | 15.051          | 9.20393           | -129.5         | 0.008664          | -16.9          | 0.1294            | 9.578          | 6.2    |
| 3000    | 0.10595           | 33.415          | 8.68177           | -135.4         | 0.007541          | -9.957         | 0.1127            | 18.402         | 7.5    |
| 3200    | 0.11609           | 42.888          | 8.18809           | -142.2         | 0.006655          | -0.835         | 0.092234          | 23.406         | 9.0    |
| 3400    | 0.10827           | 50.017          | 7.93039           | -151.5         | 0.006042          | 12.444         | 0.059268          | 26.453         | 10.3   |
| 3600    | 0.09866           | 60.967          | 7.77538           | -162.2         | 0.006205          | 29.297         | 0.015829          | 38.211         | 10.3   |
| 3800    | 0.08693           | 80.355          | 7.33775           | -172.6         | 0.007039          | 40.351         | 0.028159          | -152.8         | 9.6    |
| 4000    | 0.10090           | 102.07          | 6.90878           | 177.1          | 0.008241          | 46.053         | 0.075298          | -133.1         | 8.7    |

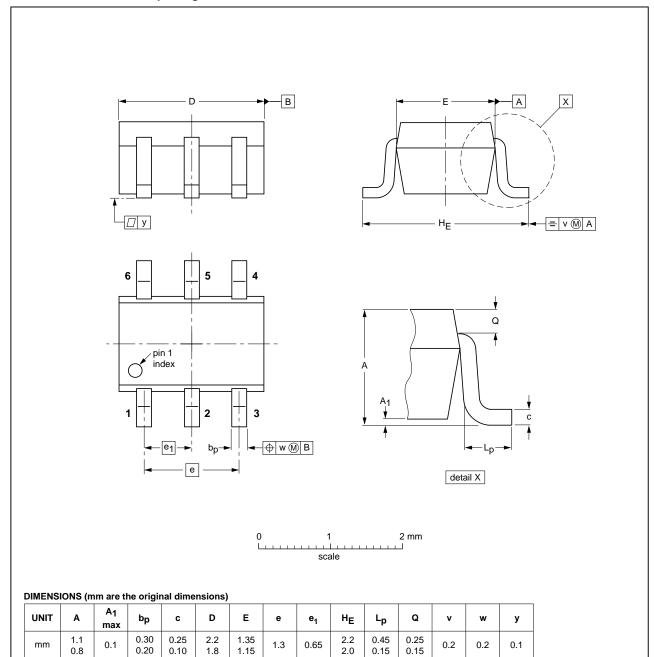
## MMIC wideband amplifier

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## **PACKAGE OUTLINE**

Plastic surface-mounted package; 6 leads

**SOT363** 



| OUTLINE |     | REFER | EUROPEAN | ISSUE DATE |            |                                 |
|---------|-----|-------|----------|------------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA    |            | PROJECTION | ISSUE DATE                      |
| SOT363  |     |       | SC-88    |            |            | <del>04-11-08</del><br>06-03-16 |

## MMIC wideband amplifier

**BGM1012** 

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|-----------------------------------|----------------------------------|---|
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## MMIC wideband amplifier

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